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(12) **United States Design Patent**
Saiwai et al.

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(45) **Date of Patent:** **** Jan. 11, 2022**

(54) **THERMAL CONDUCTION METAL MATERIAL**

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(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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Sep. 26, 2018 (JP) 2018-020958
Sep. 26, 2018 (JP) 2018-020959

(51) **LOC (13) Cl.** **15-09**

(52) **U.S. Cl.**
USPC **D15/144**

(58) **Field of Classification Search**
USPC D15/144, 144.1, 144.2; D25/1, 25, 154
CPC B29C 48/08
See application file for complete search history.

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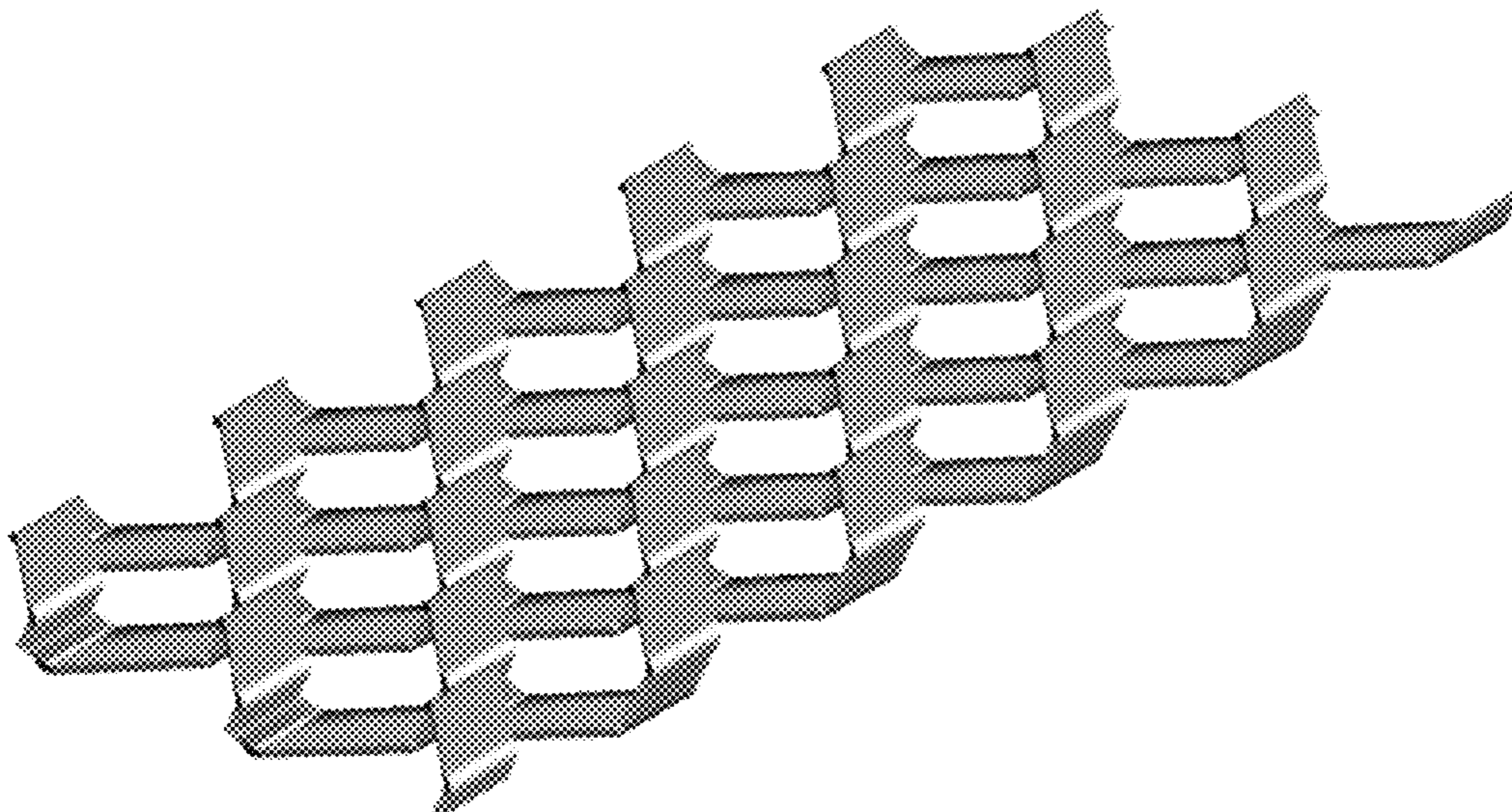
(57) **CLAIM**

The ornamental design for a thermal conduction metal material, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view from the top and left side of thermal conduction metal material.
FIG. 2 is a perspective view from the bottom and left side thereof.
FIG. 3 is a perspective view from the top and right side thereof.
FIG. 4 is a top plan view thereof.
FIG. 5 is a bottom plan view thereof.
FIG. 6 is a front elevation view thereof.
FIG. 7 is a rear elevation view thereof.
FIG. 8 is a left side elevation view thereof.
FIG. 9 is a right side elevation view thereof.
FIG. 10 is an enlarged cross-sectional view taken along the line 10-10 in the FIG. 4.
FIG. 11 is an enlarged cross-sectional view taken along the line 11-11 in the FIG. 4.
FIG. 12 is an enlarged cross-sectional view taken along the line 12-12 in the FIG. 4; and,
FIG. 13 is an enlarged cross-sectional view taken along the line 13-13 in the FIG. 4.
The design shown is not to be limited to any particular size and may be scaled larger or smaller.

1 Claim, 13 Drawing Sheets



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FIG. 1

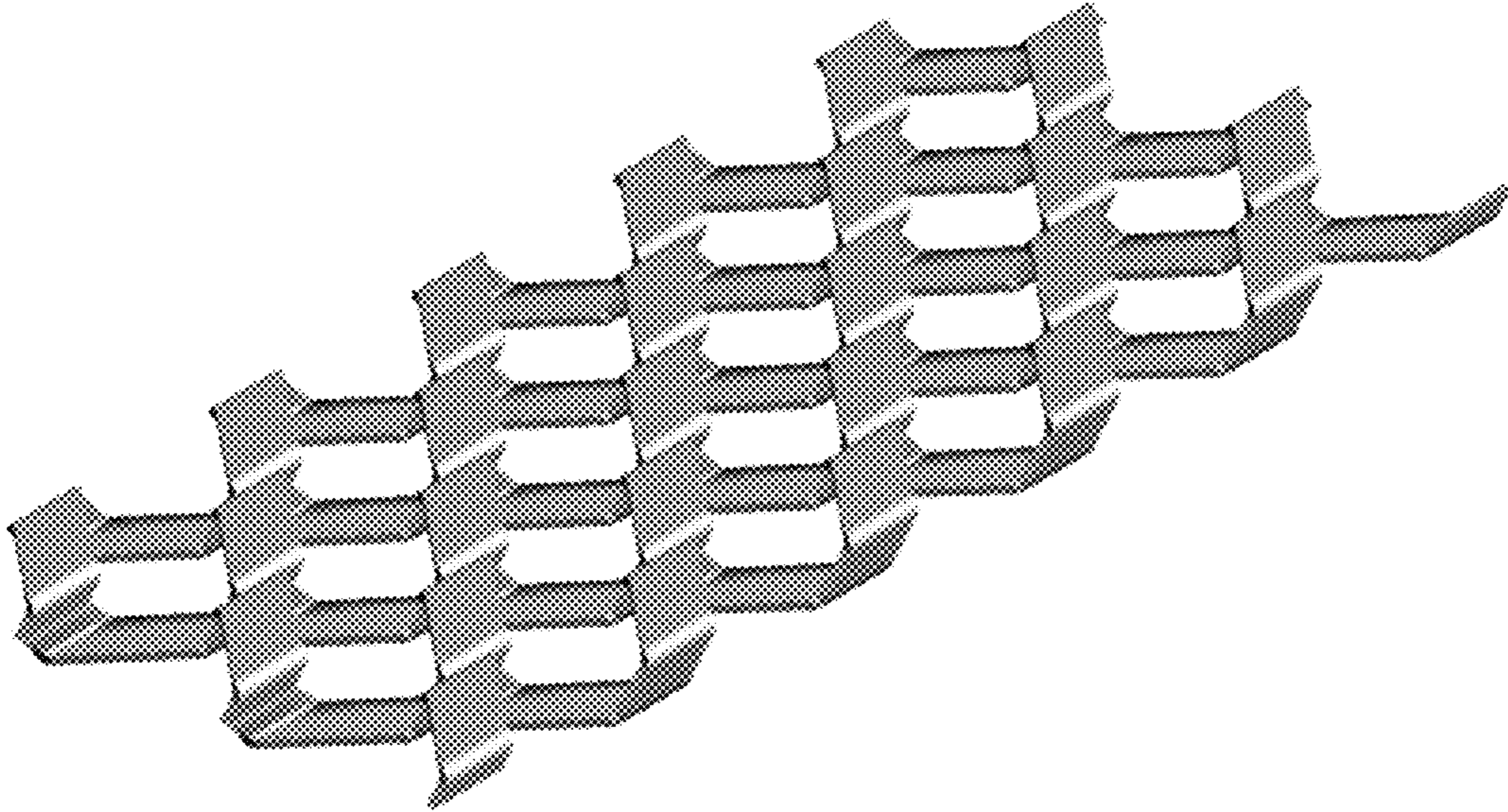


FIG. 2

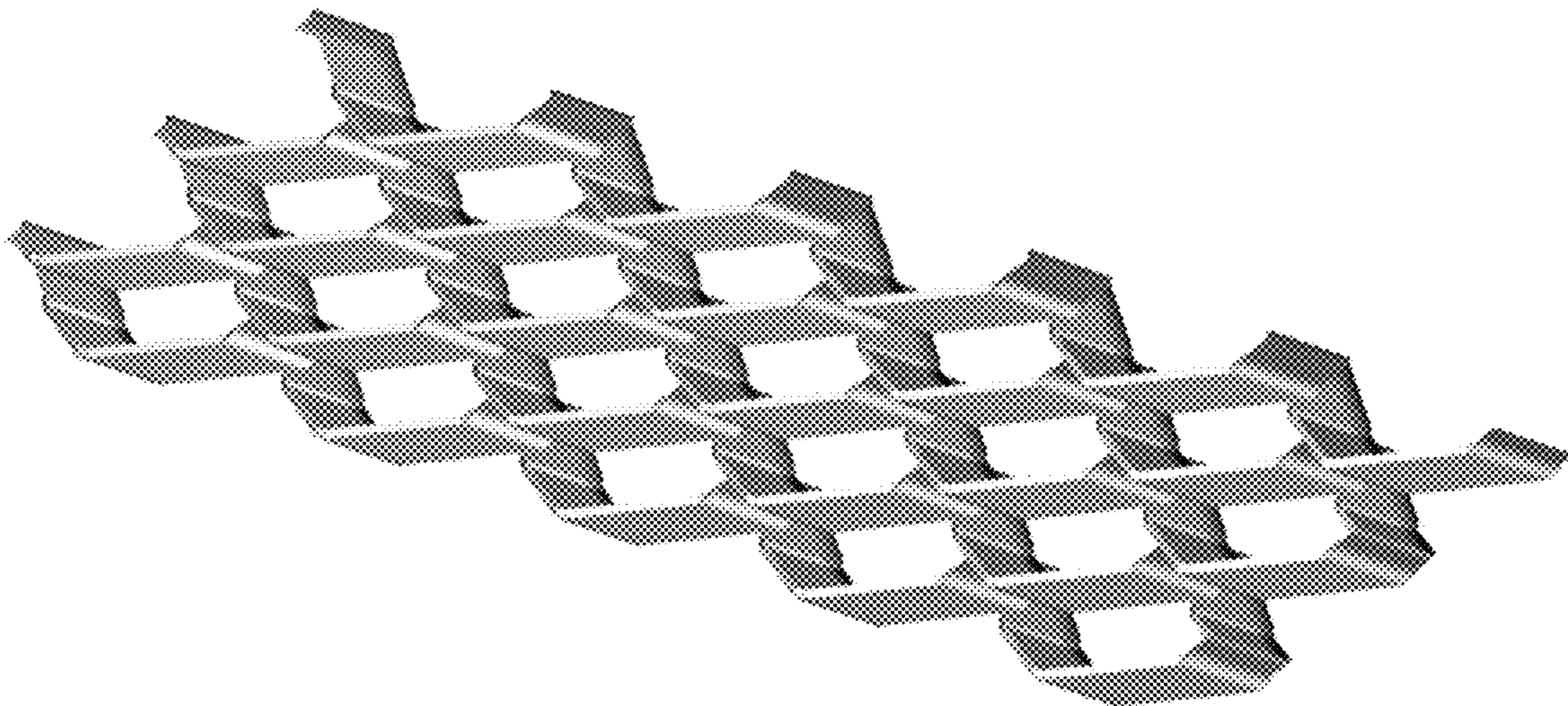


FIG. 3

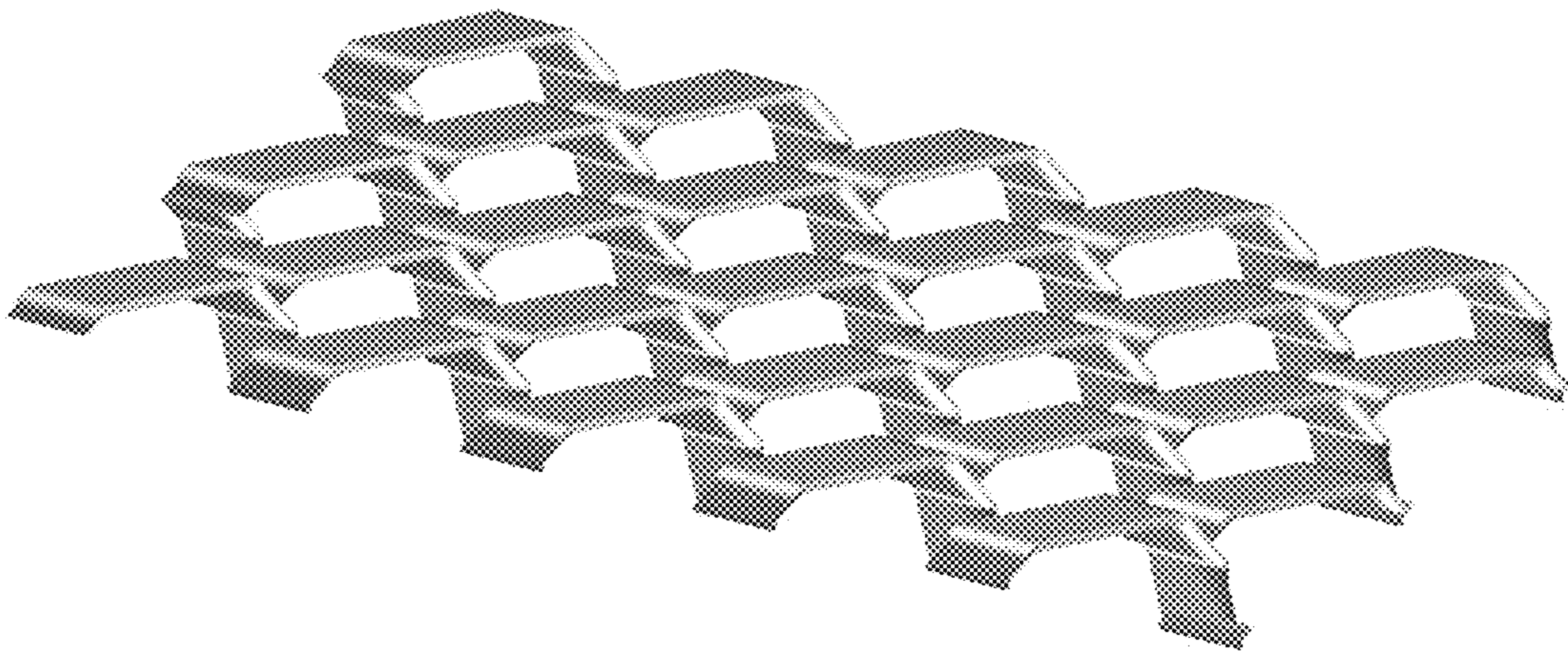


FIG. 4

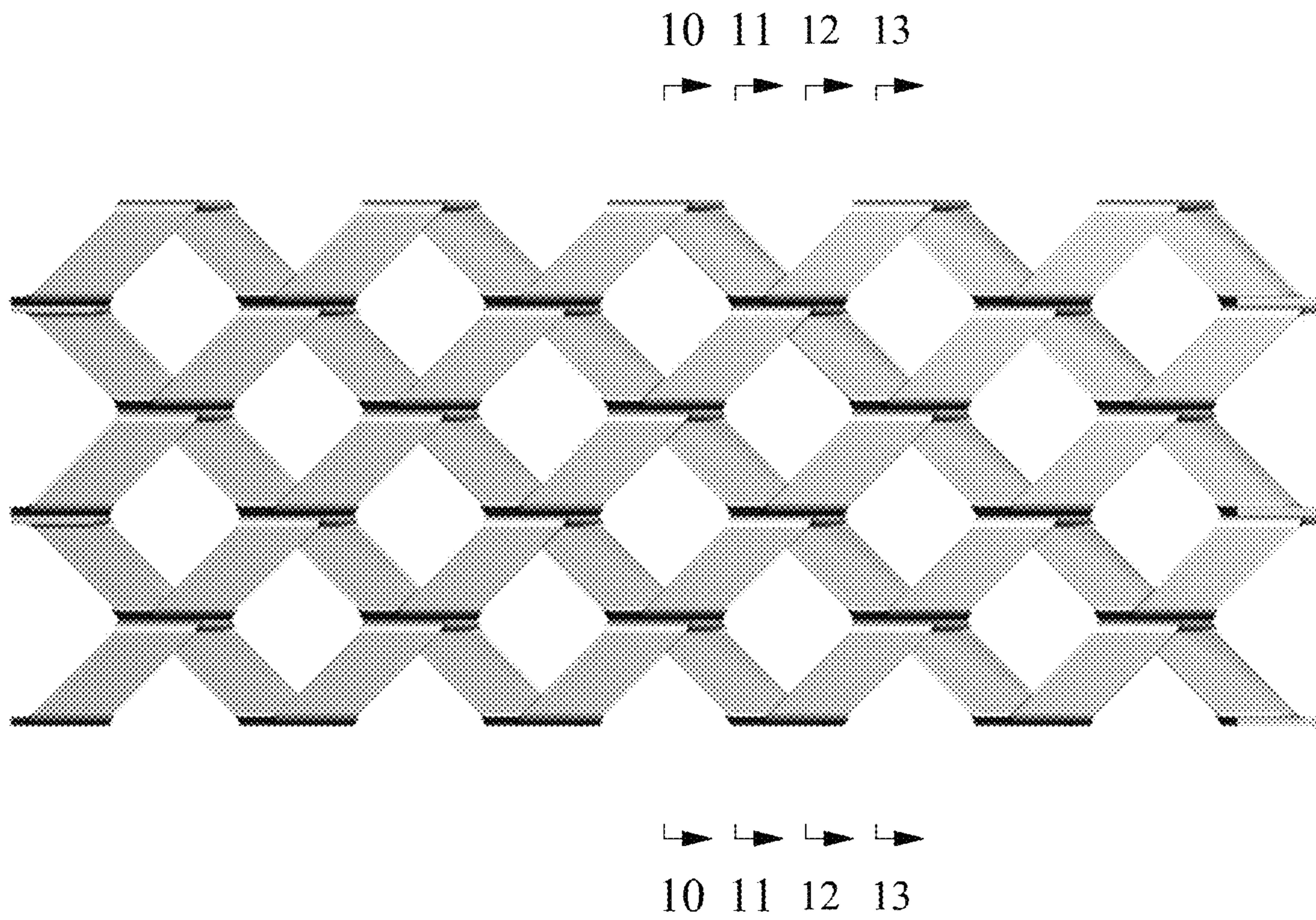


FIG. 5

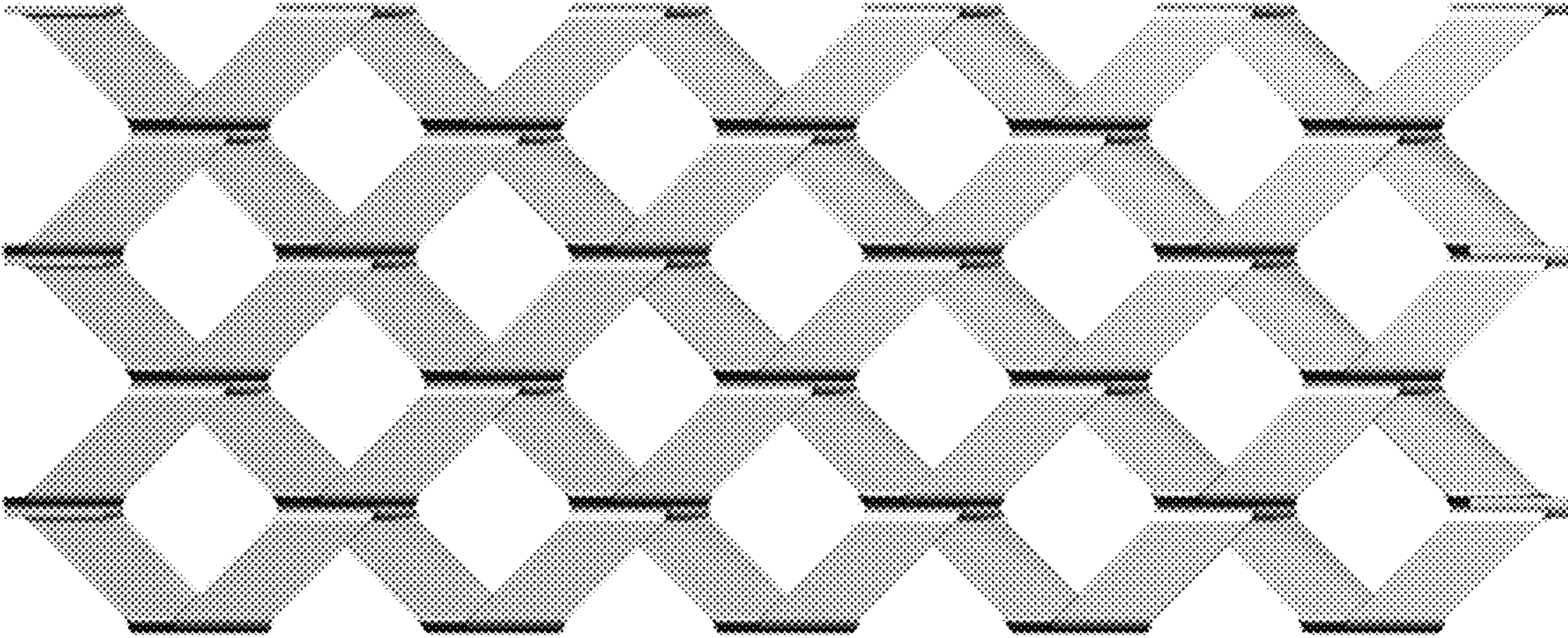


FIG. 6

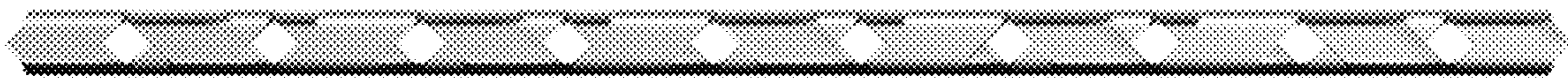


FIG. 7

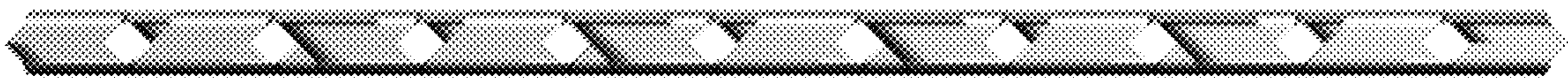


FIG. 8



FIG. 9



FIG. 10

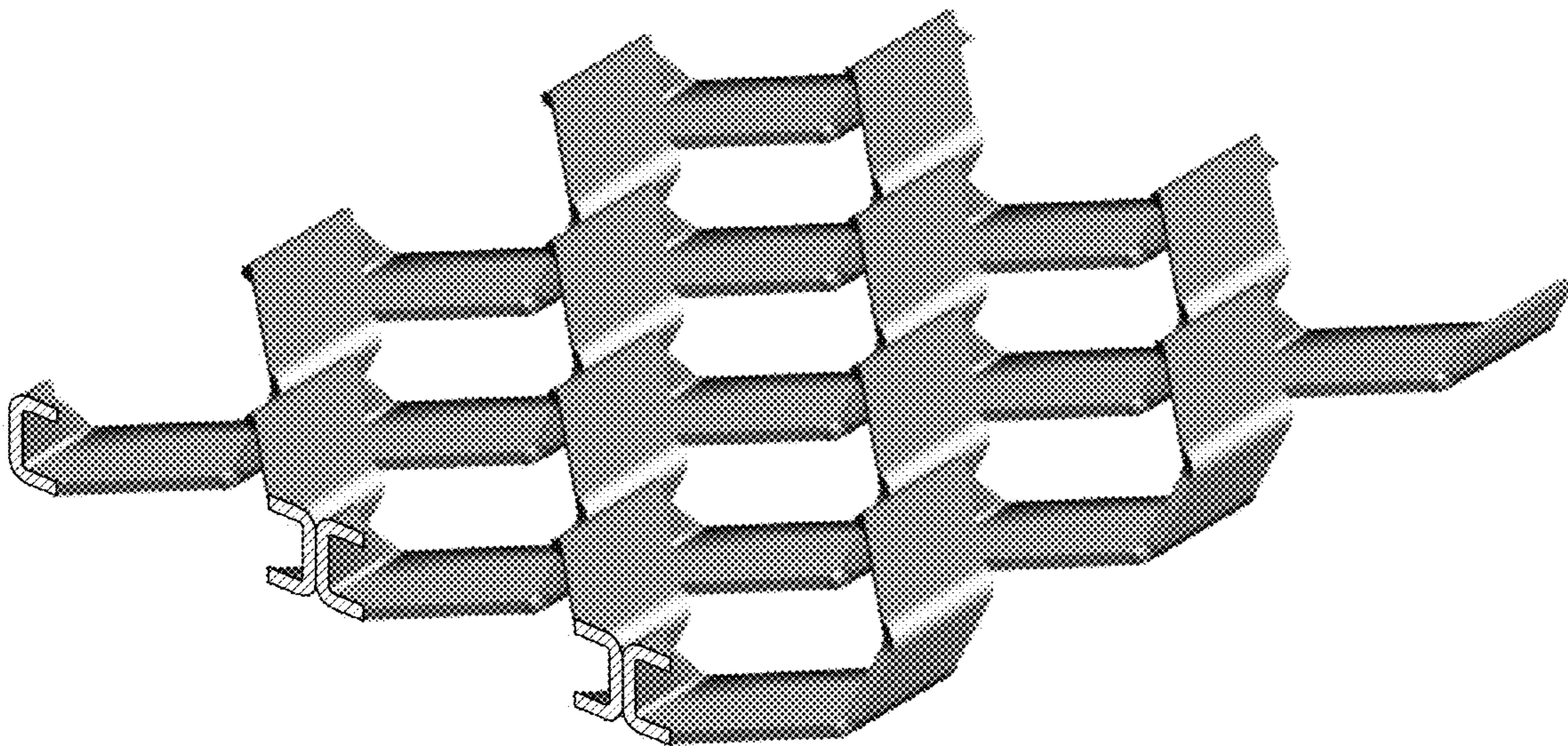


FIG. 11

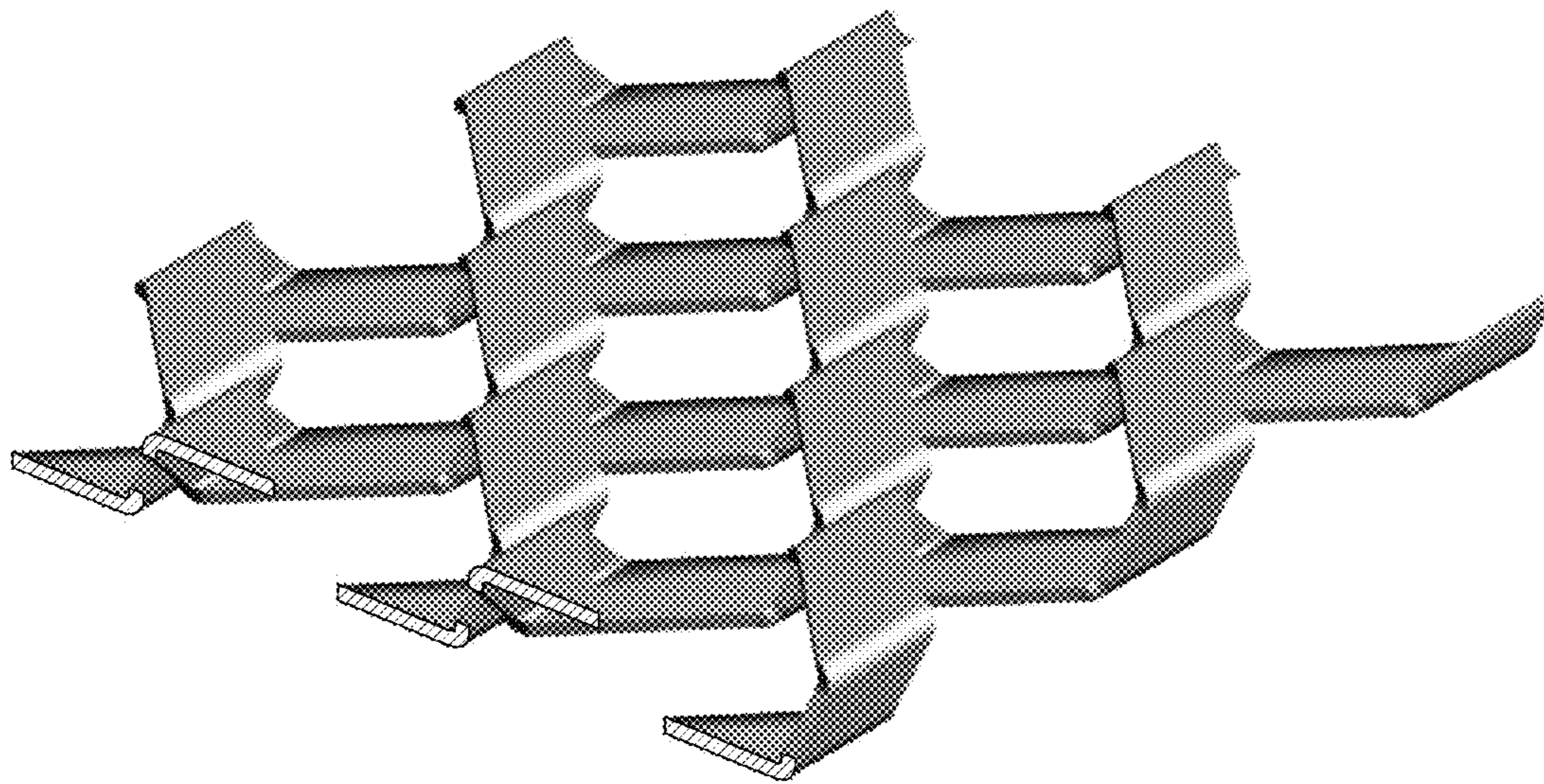


FIG. 12

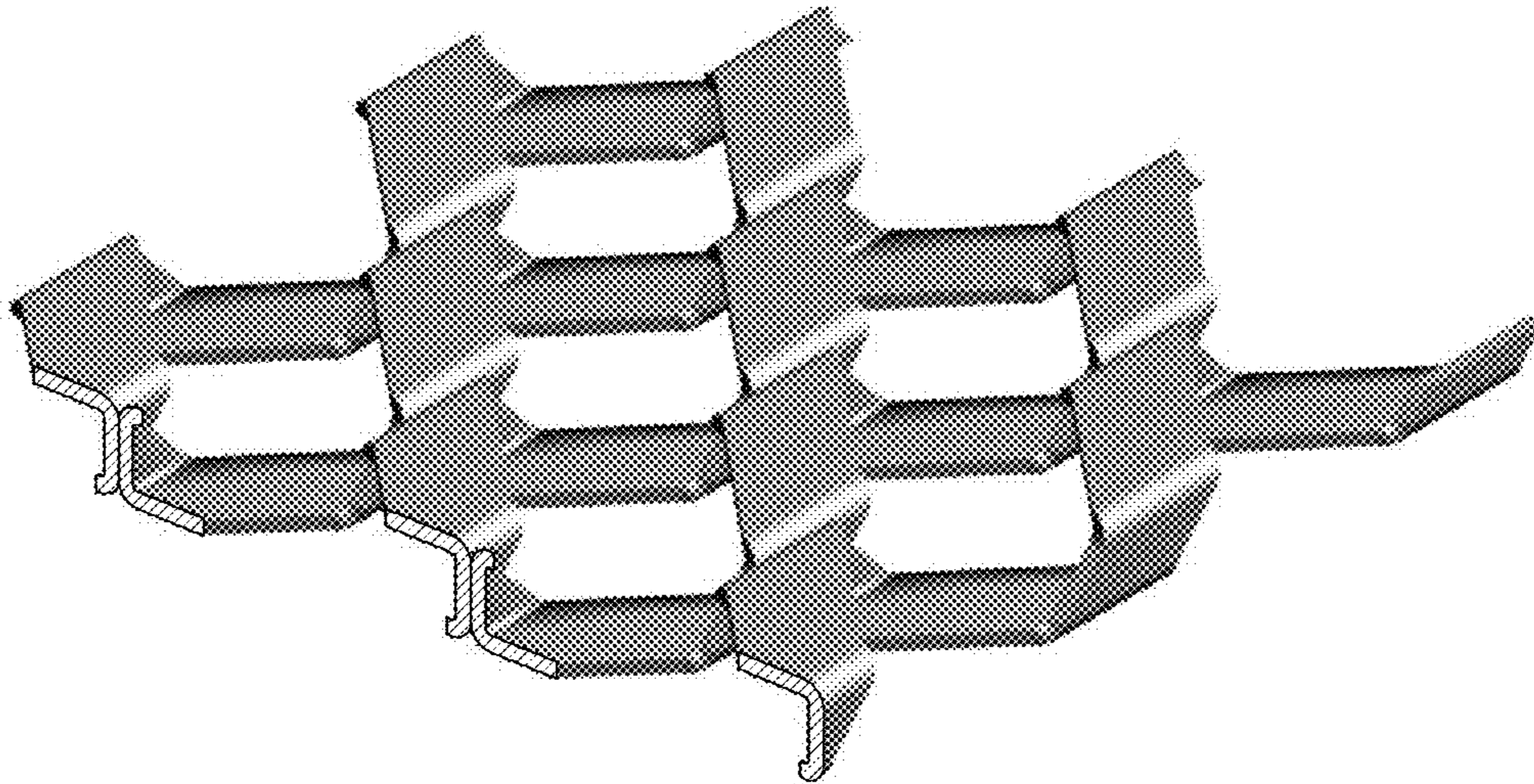


FIG. 13

